

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S10 2	183	cmp and bow\$3 with pressure	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/29 11:15
S10 1	7	nutool and bow\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/29 11:15
S10 3	33	("5816900").URPN.	USPAT	OR	ON	2006/06/29 11:25
S26	19	451/41.ccls. and air adj bladder	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 11:31
S10 4	24	nagahara\$-ron\$.in. and cmp	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:35
S10 9	245	(flex flexes flexing) with bubble	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:38
S10 8	0	cmp and (flex flexes flexing) with bubble	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:38
S10 7	3	cmp and (bow bowing bows) with bubble	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:38
S11 0	1	(flex flexes flexing) with bubble and ("204" "205" "451").clas.	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:39
S11 2	29	(bulges bulging convex convexes convexing) with bubble and (cmp chemical adj mechanical)	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:50
S11 1	33	(bulges bulging convex convexes convexing) with bubble and ("204" "205" "451").clas.	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:50
S11 3	29	(bulges bulging convex convexes convexing) with bubble and (cmp chemical adj mechanical ecmp electrochemical adj mechanical)	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:53
S11 4	3	(bulge bulging convex convexing bow bowing flex flexing) same immers\$4 with bubble and (cmp chemical adj mechanical ecmp electrochemical adj mechanical)	US-PGPUB; USPAT; USOCR	OR	ON	2006/06/29 16:54

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S11 5	300	bubble same (immers\$3 contact\$3) same center same edge	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/05 17:09
S11 8	87	S117 not S116	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/05 17:16
S11 7	124	bubble same (immers\$3 contact\$3) same center and (electroplat\$ electrochemical)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/05 17:16
S11 6	37	bubble same (immers\$3 contact\$3) same center same edge and (electroplat\$ electrochemical)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/05 17:16
S12 0	2	"20020130034".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/05 17:27
S11 9	37	S118 and ("204" "205" "451").clas.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/07/05 17:27
S12 1	8	("20030106802" "5327921" "6136163" "6274023" "6274024" "6395101" "6551487" "6582578"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/05 17:31
L6	8	("20030106802" "5327921" "6136163" "6274023" "6274024" "6395101" "6551487" "6582578"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/07 11:27
L7	1914	15/77.ccls. 15/88.2.ccls. 15/102.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/07 11:28
L9	1706	(cmp ecmp) and bubble and (semiconductor wafer microelectronic microfeature)	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/07 11:43
L8	37	L7 and bubble	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/07 11:43

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L10	99	(cmp ecmp) and bubble same immers\$4 and (semiconductor wafer microelectronic microfeature)	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/07 11:44
L11	9	(cmp ecmp) and bubble same immers\$4 same center and (semiconductor wafer microelectronic microfeature)	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/07 13:57
L14	1	"6175983".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2006/07/07 14:09
L15	3	polishing adj pad.clm. and (bow bowing).clm. and (wafer semiconductor microelectronic microfeature).clm.	US-PGPUB	OR	ON	2006/07/07 14:10
L17	85	pad.clm. and (flex flexing bulge bulging).clm. and (wafer semiconductor microelectronic microfeature).clm.	US-PGPUB	OR	ON	2006/07/07 14:11
L16	10	pad.clm. and (bow bowing).clm. and (wafer semiconductor microelectronic microfeature).clm.	US-PGPUB	OR	ON	2006/07/07 14:11
L18	5	pad.clm. and (flex flexing bulge bulging).clm. and (wafer semiconductor microelectronic microfeature).clm. and (anode cathode electrode).clm.	US-PGPUB	OR	ON	2006/07/07 14:12